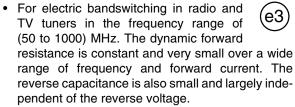


Vishay Semiconductors

Band Switching Diodes

Features

Silicon Epitaxial Planar Diode Switches



- These diodes are also available in SOD123 case with the type designations BA782 and BA783.
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Mechanical Data

Case: SOD323 Plastic case Weight: approx. 5.0 mg Packaging Codes/Options: GS18/10 k per 13" reel (8 mm tape), 10 k/box GS08/3 k per 7" reel (8 mm tape), 15 k/box

Parts Table

Part	Ordering code	Type Marking	Remarks
BA782S	BA782S-GS18 or BA782S-GS08	R2	Tape and Reel
BA783S	BA783S-GS18 or BA783S-GS08	R3	Tape and Reel

Absolute Maximum Ratings

 $T_{amb} = 25$ °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit	
Reverse voltage		V _R	35	V	
Forward continuous current	T _{amb} = 25 °C	١ _F	100	mA	

Thermal Characteristics

 $T_{amb} = 25 \text{ °C}$, unless otherwise specified

ame					
Parameter	Test condition	Symbol	Value	Unit	
Junction temperature		Tj	125	°C	
Storage temperature range		T _{stg}	- 55 to + 125	°C	





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Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 100 mA		V _F			1000	mV
Leakage current	V _R = 20 V		I _R			50	nA
Dynamik forward resistance	f = (50 to 1000) MHz, I _F = 3 mA	BA782S	r _f			0.7	Ω
		BA783S	r _f			1.2	Ω
	f = (50 to 1000) MHz, I _F = 10 mA	BA782S	r _f			0.5	Ω
		BA783S	r _f			0.9	Ω
Diode capacitance	V _R = 1 V, f = 1 MHz		CD			1.5	pF
	V _R = 3 V, f = 1 MHz	BA782S	CD			1.25	pF
		BA783S	CD			1.2	pF
Series inductance across case			L _S		2.5		nH

Typical Characteristics

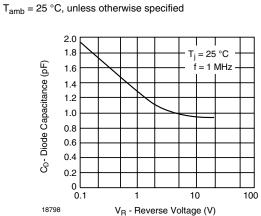


Figure 1. Diode Capacitance

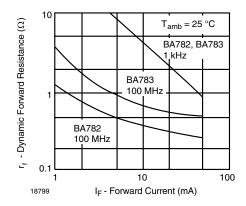
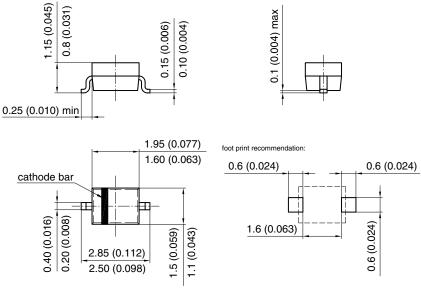


Figure 2. Dynamic Forward Resistance vs. Forward Current



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Package Dimensions in mm (Inches): SOD323



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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



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